



INTEL® STRATIX® 10 DX PRODUCT TABLE

PRODUCT LINE		DX 1100	DX 2100	DX 2800
Resources	Logic elements (LEs) ¹	1,325,000	2,073,000	2,753,000
	Adaptive logic modules (ALMs)	449,280	702,720	933,120
	ALM registers	1,797,120	2,810,880	3,732,480
	Hyper-Registers from Intel® Hyperflex™ FPGA architecture	Millions of Hyper-Registers distributed throughout the monolithic FPGA fabric		
	Programmable clock trees synthesizable	Hundreds of synthesizable clock trees		
	HBM2 High-bandwidth DRAM memory stacks	–	2	–
	HBM2 High-bandwidth DRAM memory size (GB)	–	8	–
	eSRAM memory blocks	–	2	–
	eSRAM memory size (Mb)	–	94.5	–
	M20K memory blocks	5,461	6,847	11,721
	M20K memory size (Mb)	107	134	229
	MLAB memory size (Mb)	7	11	15
	Variable-precision digital signal processing (DSP) blocks	2,592	3,960	5,760
	18 x 19 multipliers	5,184	7,920	11,520
	Peak fixed-point performance (TMACS) ²	10.4	15.8	23.0
	Peak floating-point performance (TFLOPS) ³	4.1	6.3	9.2
I/O and Architectural Features	Secure device manager	AES-256/SHA-256 bitstream encryption/authentication, physically unclonable function (PUF), ECDSA 256/384 boot code authentication, side channel attack protection		
	Hard processor system ⁴	Quad-core 64-bit Arm® Cortex®-A53 up to 1.5 GHz with 32KB I/D cache, NEON® coprocessor, 1 MB L2 cache, direct memory access (DMA), system memory management unit, cache coherency unit, hard memory controllers, USB 2.0 x2, 1G EMAC x3, UART x2, SPI x4, I2C x5, general purpose timers x7, watchdog timer x4		
		Yes	–	–
	Maximum user I/O pins	528	612	816
	Maximum LVDS pairs 1.6 Gbps (RX or TX)	264	306	408
	Total full duplex transceiver count - non return to zero (NRZ)	32	84	84
	GXE transceiver count - PAM4 (up to 57.8 Gbps) or NRZ (up to 28.9 Gbps)	8 PAM-4, or 16 NRZ	12 PAM-4, or 24 NRZ	4 PAM-4, or 8 NRZ
	GXP transceiver count - NRZ (up to 16 Gbps)	16	60	76
	UPI/PCI Express® (PCIe®) Gen4 x16 hard intellectual property (IP) blocks (configurable for UPI or PCIe operation)	–	3	3
	PCI Express Gen4 x16 hard IP blocks (supports PCIe only)	1	–	1
	100G Ethernet media access control (MAC) + forward error correction (FEC) hard IP blocks	4	4	2
Memory devices supported	Intel Optane™ Persistent Memory, DDR4, DDR3, DDR2, DDR, QDR II, QDR II+, RLD RAM II, RLD RAM 3			
Package Options and I/O Pins: General-Purpose I/O (GPIO) Count, High-Voltage I/O Count, LVDS Pairs, P-Tile Transceiver Count and E-Tile Transceiver Count				
F1760 pin (42.5 mm x 42.5 mm, 1.0 mm pitch)	528,0,264,16,16	–	–	–
F2597 pin (52.5 mm x 52.5 mm, 1.0 mm pitch)	–	612,0,306,60,24	–	–
F2912 pin (55 mm x 55 mm, 1.0 mm pitch)	–	–	–	816,0,408,76,8

Notes:

- LE counts valid in comparing across Intel FPGA devices, and are conservative vs. competing FPGAs.
- Fixed-point performance assumes the use of pre-adder.
- Floating-point performance is IEEE-754 compliant single-precision.
- Quad-core Arm Cortex-A53 hard processor system present in select Intel Stratix 10 DX devices.
- All data is preliminary and subject to change without prior notice.

816,0,408,76,8 Numbers indicate total GPIO count, high-voltage I/O count, LVDS pairs, P-Tile transceiver count, E-Tile transceiver count.



INTEL STRATIX 10 DX PRODUCT TABLE

PRODUCT LINE	DX 1100
Processor	Quad-core 64 bit Arm Cortex-A53 MPCore* processor
Maximum processor frequency	1.5 GHz ¹
Processor cache and co-processors	<ul style="list-style-type: none">• L1 instruction cache (32 KB)• L1 data cache (32 KB) with error correction code (ECC)• Level 2 cache (1 MB) with ECC• Floating-point unit (FPU) single and double precision• Arm NEON media engine• Arm CoreSight* debug and trace technology• System Memory Management Unit (SMMU)• Cache Coherency Unit (CCU)
Scratch pad RAM	256 KB
HPS DDR memory	DDR4, DDR3 (Up to 64 bit with ECC)
Direct memory access (DMA) controller	8 channels
EMAC	3X 10/100/1000 Ethernet media access controller (EMAC) with integrated DMA
USB on-the-go (OTG) controller	2X USB OTG with integrated DMA
UART controller	2X UART 16550 compatible
Serial peripheral interface (SPI) controller	4X SPI
I ² C controller	5X I ² C
Quad SPI flash controller	1X SIO, DIO, QIO SPI flash supported
SD/SDIO/MMC controller	1X eMMC 4.5 with DMA and CE-ATA support
NAND flash controller	<ul style="list-style-type: none">• 1X ONFI 1.0 or later• 8 and 16 bit support
General-purpose timers	4X
Software-programmable general-purpose I/Os (GPIOs)	Maximum 48 GPIOs
HPS DDR Shared I/O	3X 48 - May be assigned to HPS for HPS DDR access
Direct I/Os	48 I/Os to connect HPS peripherals directly to I/O
Watchdog timers	4X
Security	Secure device manager, Advanced Encryption Standard (AES) AES-256/SHA-256 bitsream encryption/authentication, PUF, ECDSA 256/384 boot code authentication, side channel attack protection

Notes:

1. With overdrive feature.

To learn more about the Intel Optane Persistent Memory, visit the [Intel Optane Persistent Memory web page](#).